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PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hideki Uchida et al.  
Serial No.: 10/016,455 Art Unit: 2811  
Filing Date: December 10, 2001  
Title: VISCOUS FLUID TRANSFER APPARATUS AND  
TRANSFER METHOD, ELECTRONIC  
COMPONENT MOUNTING APPARATUS AND  
MOUNTING METHOD, AND SEMICONDUCTOR  
DEVICE  
Docket No.: 34236

INFORMATION DISCLOSURE STATEMENT

Asst. Commissioner for Patents  
Washington, D.C. 20231

Sir/Madam:

In accordance with Rule 56, applicants are aware of the publications listed in  
the European Search Report (copy enclosed) and in the enclosed copy of Patent Office  
Form 1449. A copy of each of the publications is enclosed herewith.

Respectfully submitted,

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Date

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Form PTO-149	APR 29 2002	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. 34326	SERIAL NO. 10/016,455
INFORMATION DISCLOSURE CITATION BY APPLICANT (USE SEVERAL SHEETS IF NECESSARY)			APPLICANT: Hodaki Uchida et al.	
			FILING DATE: December 10, 2001	GROUP ART UNIT: 2811

U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Date	Name	Class	Subclass	Filing Date if Appropriate
	A	5,601,229	02/1997	Nakazato et al.			
	B	5,791,243	08/1998	Marcoux et al.			
	C						
	D						
	E						
	F						
	G						
	H						

FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Subclass	Translation
	I	62 056145	03/1987	JP			English Abstract
	J	06 238869	08/1994	JP			English Abstract
	K	08 187836 A	07/1996	JP			English Abstract
	L	11 198348	07/1999	JP			English Abstract
	M						

OTHER REFERENCES (Indicate Title, Date, Reel/Sheet, Page No.)

	N	IBM Technical Disclosure Bulletin, IBM Corp. New York, "KNOWN GOOD DYE TEST AND DIRECT CHIP ATTACH ASSEMBLY", July 1, 1996, pages 215, 217, Vol. 39 No. 07
	O	
	P	

Examiner:

Date Considered

\*Examiner: Initial if reference considered, regardless of whether citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.